# RUC002N05 HZG

Nch 50V 200mA Small Signal MOSFET

Datasheet

# **AEC-Q101 Qualified**

V <sub>DSS</sub>	50V
R <sub>DS(on)</sub> (Max.)	2.2Ω
l <sub>D</sub>	±200mA
P <sub>D</sub>	350mW

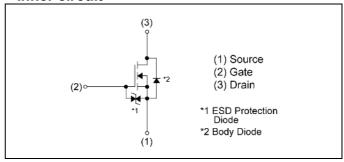
# SOT-23 SST3 (2)

# Features

- 1) Very fast switching
- 2) Ultra low voltage drive(1.2V drive)
- 3) AEC-Q101 Qualified
- 4) Pb-free lead plating; RoHS compliant.
- 5) Halogen Free.

# •Inner circuit

Outline



Packaging specifications

	Packing	Embossed Tape				
	Reel size (mm)	180				
Туре	Tape width (mm)	8				
	Quantity (pcs)	3000				
	Taping code	T116				
	Marking	RH				

# Application

Switching circuits

Low-side loadswitch

Relay driver

# ● **Absolute maximum ratings** (T<sub>a</sub> = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	50	V
Continuous drain current	I <sub>D</sub>	±200	mA
Pulsed drain current	I <sub>DP</sub> *1	±800	mA
Gate - Source voltage	$V_{GSS}$	±8	V
Down discipation	P <sub>D</sub> *2	350	mW
Power dissipation	P <sub>D</sub> *3	200	mW
Junction temperature	T <sub>j</sub>	150	°C
Operating junction and storage temperature range	T <sub>stg</sub>	-55 to +150	°C

# ●Thermal resistance

Doromotor	Cymah al	Values			1.1-:4
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal registeres innetion, ambient	R <sub>thJA</sub> *2	-	-	357	°C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub> *3	-	-	625	°C/W

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Davamatav	Cymahal	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min. Typ.		Max.	Offic	
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA	50	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I <sub>D</sub> = 1mA referenced to 25°C	-	53.7	-	mV/°C	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V	-	-	1	μA	
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$	-	-	±10	μA	
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = 10V, I_{D} = 1mA$	0.3	-	1.0	V	
Gate threshold voltage temperature coefficient			-	-1.4	-	mV/°C	
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 200mA	-	1.6	2.2		
		$V_{GS} = 2.5V, I_D = 200mA$	-	1.7	2.4		
Static drain - source on - state resistance	R <sub>DS(on)</sub> *4	V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 100mA	-	1.9	2.7	Ω	
		$V_{GS} = 1.5V, I_D = 40mA$	1	2.0	4.0		
		$V_{GS} = 1.2V, I_D = 20mA$	-	2.4	7.2		
Forward Transfer Admittance	Y <sub>fs</sub>  *4	V <sub>DS</sub> = 10V, I <sub>D</sub> = 200mA	0.4	-	-	S	

<sup>\*1</sup> Pw≦10µs, Duty cycle≦1%

<sup>\*2</sup> Mounted on a ceramic board (7.0×5.0×0.8mm)

<sup>\*3</sup> Mounted on a FR4 (20.0×12.0×0.8mm,Cu pad : 0.8mm<sup>2</sup>)

<sup>\*4</sup> Pulsed

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Daramatar	Cymahal	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	25	-	_	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10V	-	6	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	3	-		
Turn - on delay time	t <sub>d(on)</sub> *4	$V_{DD} \simeq 30V, V_{GS} = 4.5V$	-	4	-		
Rise time	t <sub>r</sub> *4	I <sub>D</sub> = 100mA	-	6	-	no	
Turn - off delay time	t <sub>d(off)</sub> *4	$R_L \simeq 300\Omega$	-	15	-	ns	
Fall time	t <sub>f</sub> *4	$R_G = 10\Omega$	-	55	-		

# ullet Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
raianetei	Symbol Conditions		Min.	Тур.	Max.	Offic	
Continuous forward current	I <sub>S</sub>	T = 25°C	-	-	150	mA	
Pulse forward current	I <sub>SP</sub> *1	T <sub>a</sub> = 25°C	-	-	800	mA	
Forward voltage	V <sub>SD</sub> *4	V <sub>GS</sub> = 0V, I <sub>S</sub> = 200mA	-	-	1.2	V	

Fig.1 Power Dissipation Derating Curve

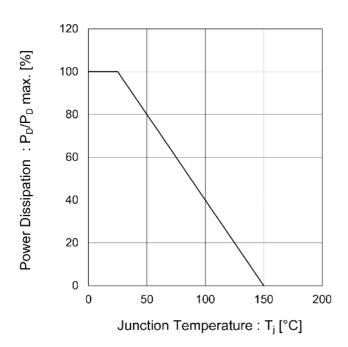
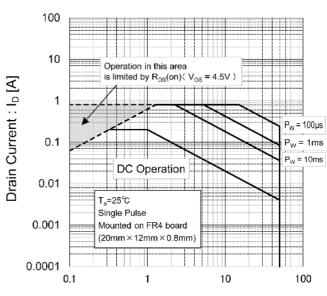


Fig.2 Maximum Safe Operating Area



Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

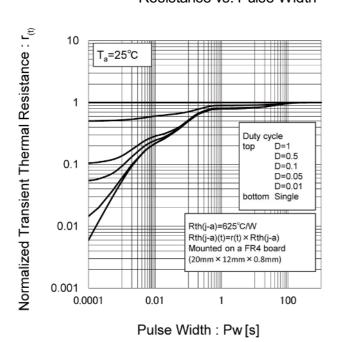
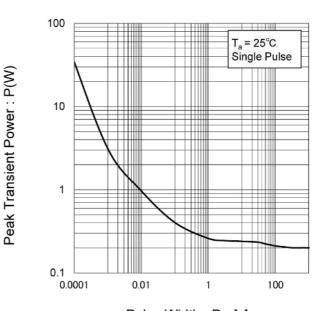


Fig.4 Single Pulse Maximum Power dissipation



Pulse Width: Pw[s]

Fig.5 Typical Output Characteristics(I)

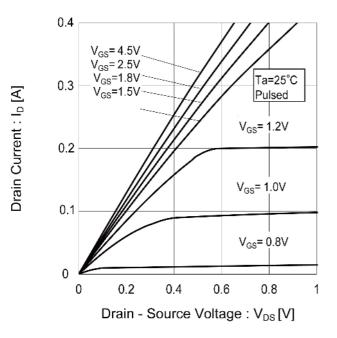
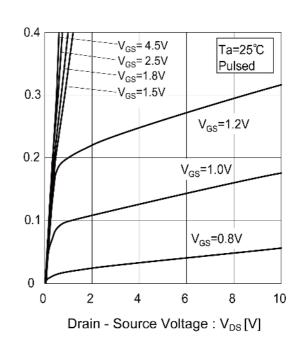


Fig.6 Typical Output Characteristics(II)



Drain Current: I<sub>D</sub> [A]

Fig.7 Breakdown Voltage vs.
Junction Temperature

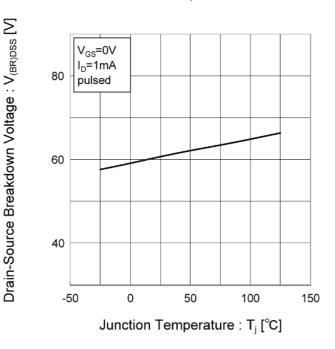


Fig.8 Typical Transfer Characteristics

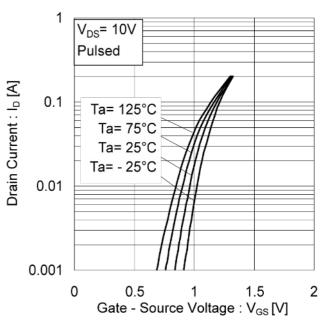


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

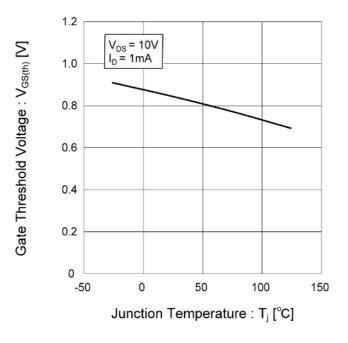
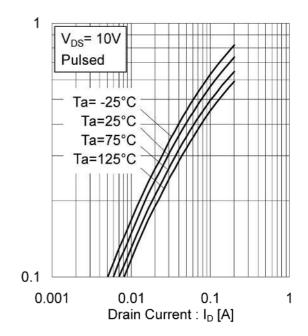


Fig.10 Forward Transfer Admittance vs.

Drain Current



Transconductance : gfs [S]

Fig.11 Drain Current Derating Curve

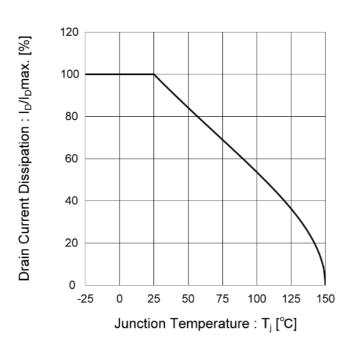


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

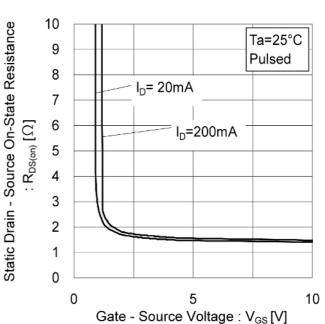


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

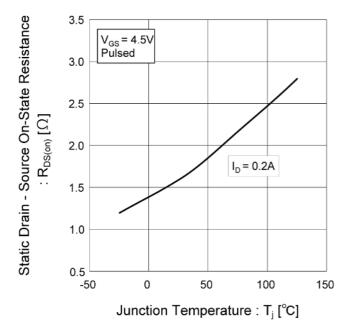


Fig.14 Static Drain - Source On - State
Resistance vs. Drain Current (I)

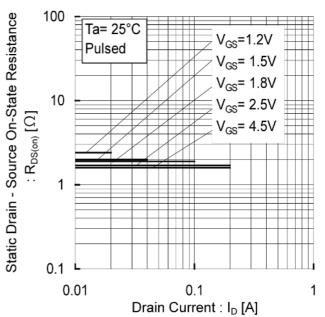


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

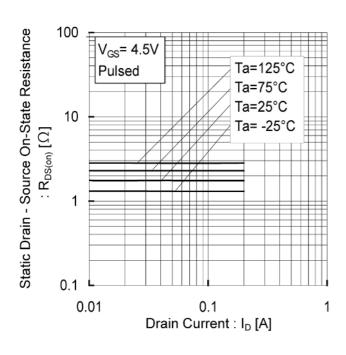


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

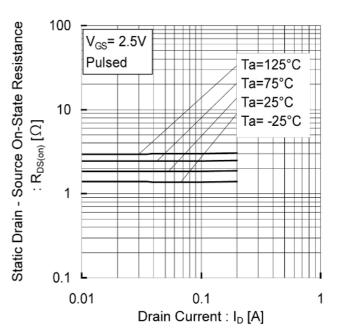


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current (IV)

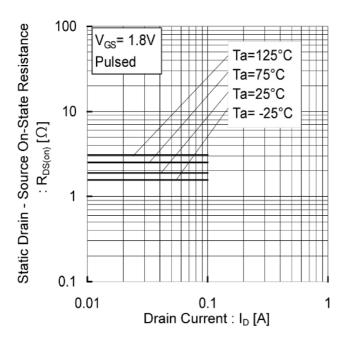


Fig.18 Static Drain - Source On - State Resistance vs. Drain Current (V)

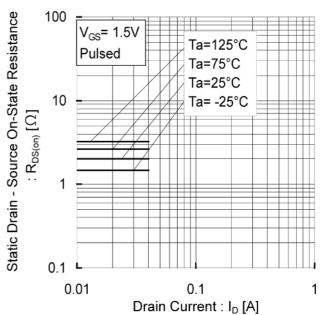


Fig.19 Static Drain - Source On - State Resistance vs. Drain Current (VI)

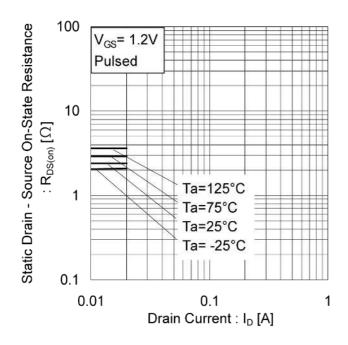


Fig.20 Typical Capacitance vs.

Drain - Source Voltage

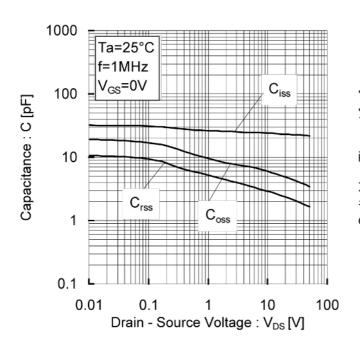


Fig.21 Switching Characteristics

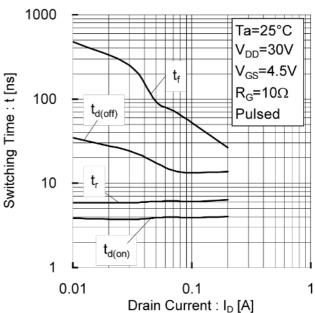
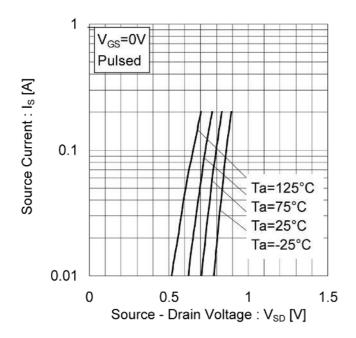


Fig.22 Source Current vs.

Source Drain Voltage



# Measurement circuits

Fig. 1-1 SWITCHING TIME MEASUREMENT CIRCUIT

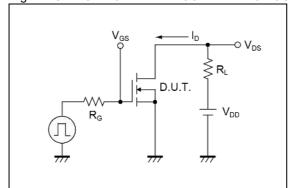
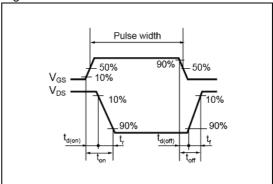


Fig. 1-2 SWITCHING WAVEFORMS

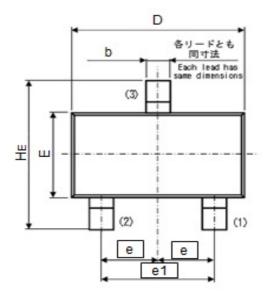


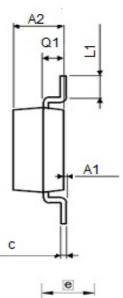
# Notice

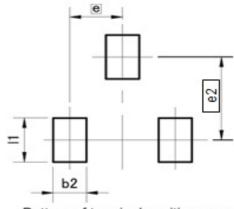
1. This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

# Dimensions

SOT-23 (SST3)







Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A1	0.00	0.10	0.000	0.004
A2	0.85	1.15	0.033	0.045
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.70	3.10	0.106	0.122
E	1.20	1.50	0.047	0.059
е	0.	95	0.0	37
e1	1.70	2.10	0.067	0.083
HE	2.20	2.60	0.087	0.102
L1	0.20	/-	0.008	_
Q1	0.35	0.55	0.014	0.022

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	_	0.60	-	0.024	
e2	1.70		0.0	67	
l1		0.90	-	0.035	

Dimension in mm/inches

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(Note1) Medical Equipment Classification of the Specific Applications

(1.1010.1) modical Equipment oldermodison of the operation inpinedia							
JAPAN	USA	EU	CHINA				
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSⅢ				
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII				

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## **Precaution for Mounting / Circuit board design**

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

## **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

# **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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